

ECX-53B **SMD CRYSTAL**

Request a Sample

The ECX-53B is a miniature SMD Crystal with a 3.2 x 5 mm footprint. This package is ideal for todays compact wireless applications where board space is critical.

ECX-53B SMD CRYSTAL

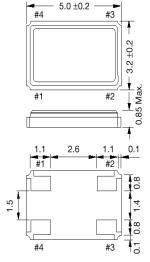


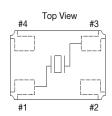
- Compact and low profile
- Industry Standard Footprint
- Extended Temp. Range Option
- RoHS Compliant

OPERATING CONDITIONS / ELECTRICAL CHARACTERISTICS

PARAMETERS	CONDITIONS		ECX-53B		UNITS
		MIN	TYP	MAX	
Frequency		8.000		50.000	MHz
Mode of Oscillation	Fundamental				
Frequency Tolerance*	@ +25°C			± 30	ppm
Frequency Stability*	-20 ~ +70°C			± 50	ppm
Shunt Capacitance	Co			5	pF
Load Capacitance	Specify in P/N	8	20	Series	pF
Drive Level	DL			100	μW
Operating Temperature*	Topr	-20		+70	°C
Storage Temperature	Tstg	-55		+125	°C
Aging (First Year)	@ +25°C ±3°C			±5	ppm

DIMENSIONS (mm)





Pad Connections			
1	In/Out		
2	Gnd		
3	Out/In		
4	Gnd		

Frequency (MHz)	ESR Ω Max.
8.000 ~ 9.999	100
10.000 ~ 15.999	80
16.000 ~ 19.999	50
20.000 ~ 23.999	40
24.000 ~ 50.000	30

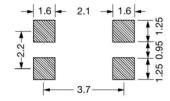


Figure 2) Suggested land

Figure 1) Top, Side, and Bottom

Crystal is symmetrical, pad 1 & 3 are interchangeable. Chamfer on the bottom pad has no electrical significance.

PART NUMBERING GUIDE: Example ECS-200-20-30B-TR

ECS - FR	EQUENCY ABBREVIATION	LOAD	PACKAGE		AVAILABLE OPT	TIONS	PACKAGING
		CAPACITANCE		Tolerance	Stability	Temp Range	
ECS	200 = 20.000 MHz See P/N Guide	20 = 20 pF S = Series	30B = ECX-53B	Blank = Std A = ± 25 ppm J = ± 20 ppm R = ± 15 ppm C = ± 10 ppm	Blank= Std D= ±100 ppm E = ± 50 ppm G = ± 30 ppm H = ± 25 ppm	Blank= Std L = -10 ~ +70°C M = -20 ~ +70°C Y = -30 ~ +85°C N = -40 ~ +85°C	& Reel

^{*} Specify available options in P/N.

 $T = \pm 20 \text{ ppm } \dagger$ $W = \pm 15 ppm †$

 $K = \pm 10 ppm \dagger$

 $P = -40 \sim +105 ^{\circ}C$ $S = -40 \sim +125 °C$ $U = -55 \sim +125 ^{\circ}C$

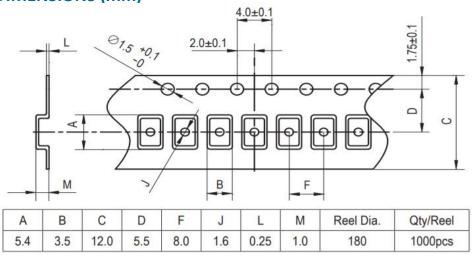
Rev.2017

[†] Contact ECS for availability over extended temp range.

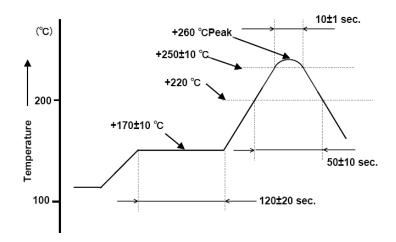




POCKET TAPE DIMENSIONS (mm)



SOLDER PROFILE			
Peak solder Temp +260°C Max 10 sec Max.			
2 Cycles Max.			
MSL 1, Lead Finish Au			



DEVELOPED FREQUENCIES			
Abbreviation	Frequency (MHZ)		
080	8.000		
100	10.000		
120	12.000		
122.8	12.288		
160	16.000		
200	20.000		
240	24.000		
245.7	24.576		
250	25.000		
270	27.000		
300	30.000		
360	36.000		
500	50.000		

Figure 1) Suggested Reflow Profile